



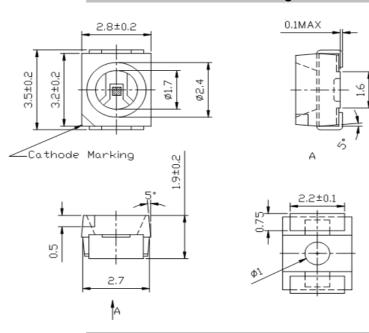




Applications

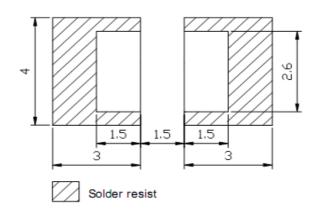
Interior automotive lighting
 Optical indicators
 Communication Products
 Backlighting
 Toys

Technical Drawing





Recommended Soldering Pattern



Notes:

All dimensions in mm tolerance is \pm 0.1mm unless otherwise noted.

PL	.C	(;2
G	re	e	n

Part No.: **M11A1021**

DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
APPD:	Ping			FINISH	Hui	Sheet	1 from 9









Absolute Maximum Ratings

Ta=25°C

Item	Symbol	 Unit
Power Dissipation	P_{D}	 mW
DC Forward Current	I _F	 mA
Plused Forward Current	I _{FP} *	 mA
Reverse Voltage	V_R	 V
Operating Temperature	T _{OP}	 °C
Storage Temperature	T _{ST}	 °C

^{* 0.1} msec pulse, 10% duty cycle

Electrcal / Optical Characteristics

I_F=20mA Ta=25°C

Ermitting Color		Green						
Material								
Forward Voltage	typ.	1.9	V_{F}					
Forward voilage	max.	2.4	V_{F}					
Wavelength	λD	565	nm					
	λP	575	nm					
typ.	Δλ		nm					
Color Temperature	min.		K					
Color remperature	max.		K					
Luminous Intensity *	min.	110	mcd					
Luminous intensity	typ.	180	mcd					
Reverse Current	max.		μΑ					
Viewing Angle	2Θ1/2	120						

^{*} Per NIST standards

PLCC2 Green

Part No.: **M11A1021**

DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
APPD:	Ping			FINISH	Hui	Sheet	2 from 9

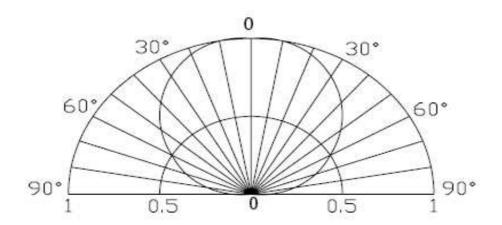








Directive Characteristics



PLCC2 Green

Part No.: **M11A1021**

DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
APPD:	Ping			FINISH	Hui	Sheet	3 from 9









PLCC2 Green

Part No.: **M11A1021**

Customer:

DRW: Dong CHKD Chang MATL: Chui DATE 06.12.2009
APPD: Ping FINISH Hui Sheet 4 from 9



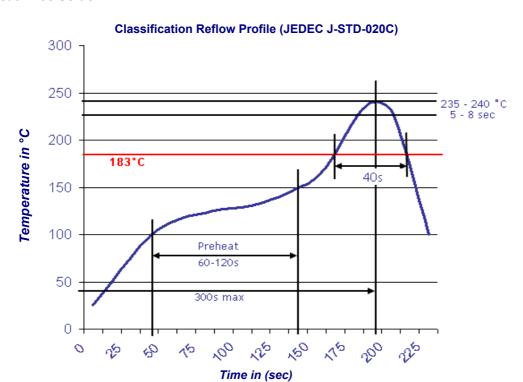






Solder Condition

Lead Free Solder



PLCC2 Green

Part No.: **M11A1021**

DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
APPD:	Ping			FINISH	Hui	Sheet	5 from 9

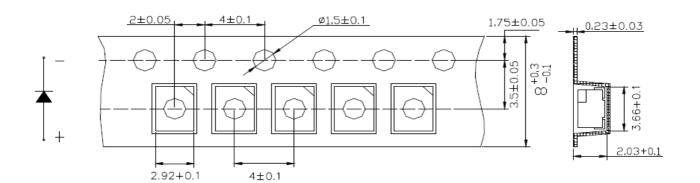




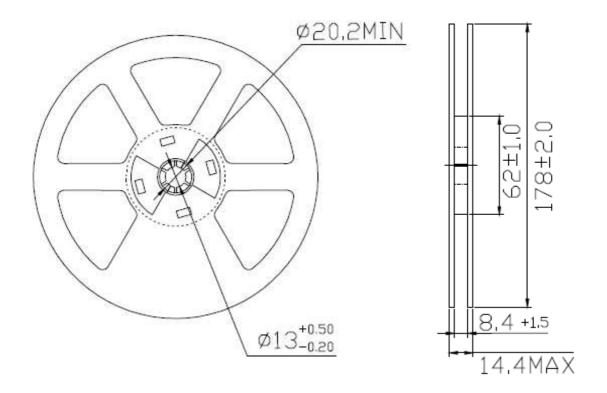




Packing Specifications



Reel Specifications



PLCC2	
Green	

Part No.: **M11A1021**

DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
APPD:	Ping			FINISH	Hui	Sheet	6 from 9





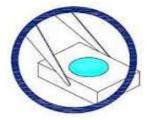




Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.





3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



PLCC2 Green

Part No.: **M11A1021**

DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
APPD:	Ping			FINISH	Hui	Sheet	7 from 9

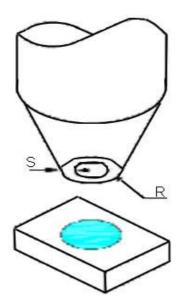








- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



PL	.C	C ₂
G	rec	<u>en</u>

Part No.: **M11A1021**

DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
APPD:	Ping			FINISH	Hui	Sheet	8 from 9

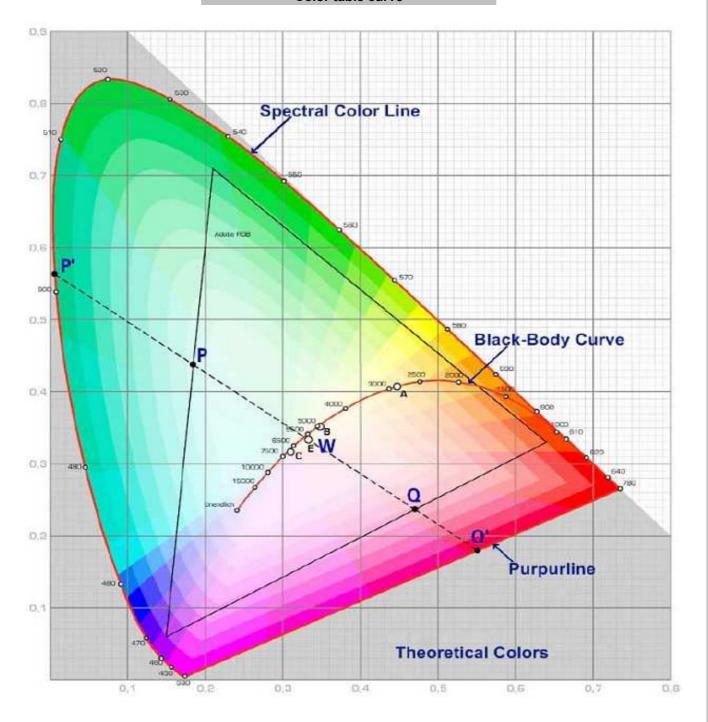








Color table curve



PLCC2	
Green	

Part No.: **M11A1021**

DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
APPD:	Ping			FINISH	Hui	Sheet	9 from 9